

DACs for Electronic Adjustment

High-precision 10bit 8ch/10ch D/A Converters



BU2506FV, BU2505FV

No.11052EBT03

●Description

BU2506FV and BU2505FV ICs are high performance 10bit R-2R type DACs with 8ch and 10ch outputs, respectively. Cascade connection is possible, ensuring suitability with multi-channel applications. Each channel incorporates a full swing output-type buffer amplifier with high speed output response characteristics, resulting in a greatly shortened wait time. The ICs also utilize the TTL level input method, and with the RESET pin the output voltage can be kept in the lower reference voltage range.

●Features

- 1) High performance, multi-channel R-2R-type 10bit D/A converter built-in (BU2506FV: 8 channels, BU2505FV: 10 channels)
- 2) Full swing output type buffer amplifier incorporated at each output channel
- 3) The RESET terminal can keep the output voltage at all channels within the lower reference voltage range
- 4) Digital input compatible with TTL levels
- 5) 14bit 3-line serial data + RESET signal input (address 4bit + data 10bit)
- 6) Cascade connection available
- 7) LSB first / MSB first of 10bit data can be changed by the REVERSE terminal
- 8) Compact package: 0.65mm pitch, 20 pins (SSOP-B20)

●Applications

DVDs, CD-Rs, CD-RWs, Digital cameras

●Lineup

Parameter	BU2505FV	BU2506FV
Power source voltage range	4.5 to 5.5V	4.5 to 5.5V
Number of channels	10ch	8ch
Differential non linearity error	±1.0LSB	±1.0LSB
Integral non linearity error	±3.5LSB	±3.5LSB
Data transfer frequency	10MHz	10MHz
Package	SSOP-B20	SSOP-B20

●Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Ratings	Unit
Power source voltage	VCC	-0.3 to 6.0	V
D/A converter upper standard voltage	VDD	-0.3 to 6.0	V
Input voltage	VIN	-0.3 to 6.0	V
Output voltage	VOUT	-0.3 to 6.0	V
Storage temperature range	T _{stg}	-55 to 125	°C
Power dissipation	P _d	400*	mW

* Derated at 4mW/°C at Ta>25°C, mounted on a 70x70x1.6mm FR4 glass epoxy board (copper foil area less than 3%)
Note: These products are not robust against radiation

●Recommended Operating Conditions(Ta=25°C)

Parameter	Symbol	Limits	Unit
Power supply voltage range	VCC	4.5 to 5.5	V
Operating temperature range	Topr	-30 to 85	°C

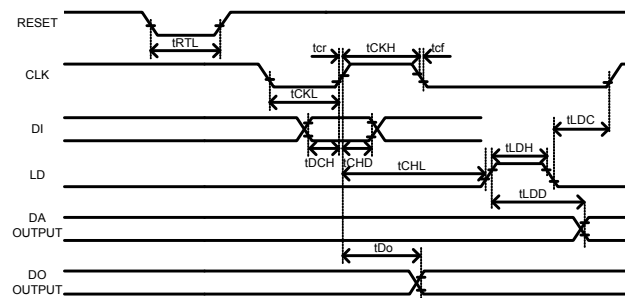
●Electrical Characteristics(Unless otherwise specified, VCC=5V, VrefH=5V, VrefL=0V, Ta=25°C)

Parameter	Symbol	Limits			Unit	Conditions
		MIN.	TYP.	MAX.		
<Digital unit>						
Power source current	ICC	-	0.85	2.8	mA	At CLK=10MHz, IAO=0μA
Input leak current	IILK	-5	-	5	μA	VIN=0 to VCC
Input voltage L	VIL	-	-	0.8	V	-
Input voltage H	VIH	2.0	-	-	V	-
Output voltage L	VOL	0	-	0.4	V	IOL=2.5mA
Output voltage H	VOH	4.6	-	5	V	IOH=-2.5mA
<Analog unit>						
Consumption current	IrefH	-	4.5	7.5	mA	Data condition : at maximum current
		-	3.7	6.2	mA ^(*1)	
D/A converter upper standard voltage setting range	VrefH	3.0	-	5	V	Outputs are not necessarily within the standard voltage setting range, but ARE within the buffer amplifier output voltage range (VO).
D/A converter lower standard voltage setting range	VrefL	0	-	1.5	V	
Buffer amplifier output voltage range	VO	0.1	-	4.9	V	IO=±100μA
		0.2	-	4.75		IO=±1.0mA
Buffer amplifier output drive range	IO	-2	-	2	mA	Upper side saturation voltage =0.35V (on full scale setting, current sourcing) Lower side saturation voltage =0.23V (on zero scale setting, current sinking)
Precision	Differential non-linearity error	DNL	-1.0	-	1.0	LSB
	Integral non-linearity error	INL	-3.5	-	3.5	
	Zero point error	SZERO	-25	-	25	mV
	Full scale error	SFULL	-25	-	25	
Buffer amplifier output impedance	RO	-	5	15	Ω	-
Pull-up I/O internal resistance value	Rup	12.5	25	37.5	kΩ	Input voltage 0V (Resistance value changes according to voltage supplied)

*1 Value in the case where CH1 ~ CH8 are set to maximum current after reset

● **Timing Characteristics**(Unless otherwise specified, VCC=5V, VrefH=5V, VrefL=0V, Ta=25°C)

Parameter	Symbol	Limits			Unit	Conditions
		MIN.	TYP.	MAX.		Judgment level is 80% / 20% of VCC.
Reset L pulse width	tRTL	50	-	-	nS	-
Clock L pulse width	tCKL	50	-	-		-
Clock H pulse width	tCKH	50	-	-		-
Clock rise time	tcr	-	-	50		-
Clock fall time	tcf	-	-	50		-
Data setup time	tDCH	20	-	-		-
Data hold time	tCHD	40	-	-		-
Load setup time	tCHL	50	-	-		-
Load hold time	tLDC	50	-	-		-
Load H pulse width	tLDH	50	-	-		-
Data output delay time	tDO	-	-	90		CL=100pF
DA output settling time	tLDD	-	7	20	μS	CL ≤ 100pF, VO: 0.5V ⇔ 4.5V. Until output value deference from final value becomes 1/2LSB.



(note) LD signal is level triggered. When LD input is on H level, internal shift-register state is loaded to DAC control latch. Clock transition during LD=H is inhibited.

● Cascade Connection

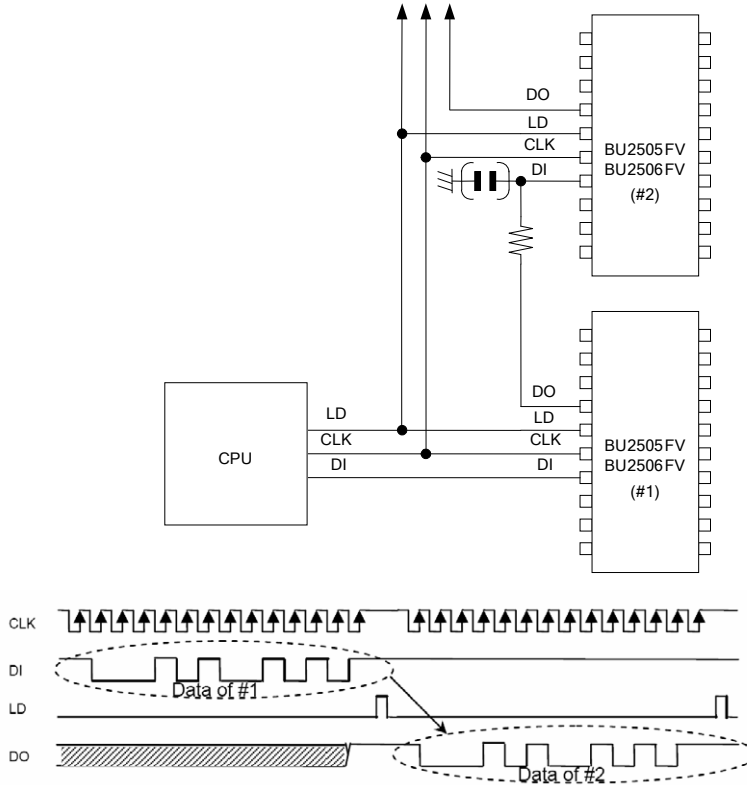
A data output terminal for cascade connection (DO) is available for reducing the number of parts when it is increased.

The DO terminal can be connected to a data input terminal (DI) of the next IC.

However, DO transition is synchronized with rising edge of clock signal, DO signal should be delayed, to keep a limit of data hold time.

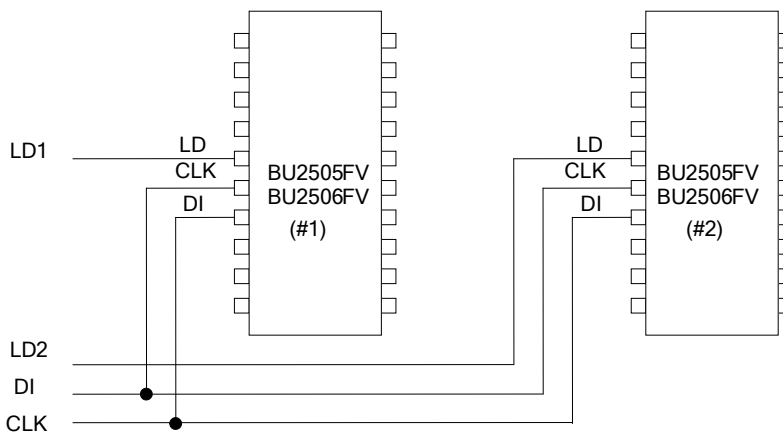
For example RC passive filter can be used.

Also in some cases, an operation frequency of logic signal have to be decreased to ensure a margin of data setup time.

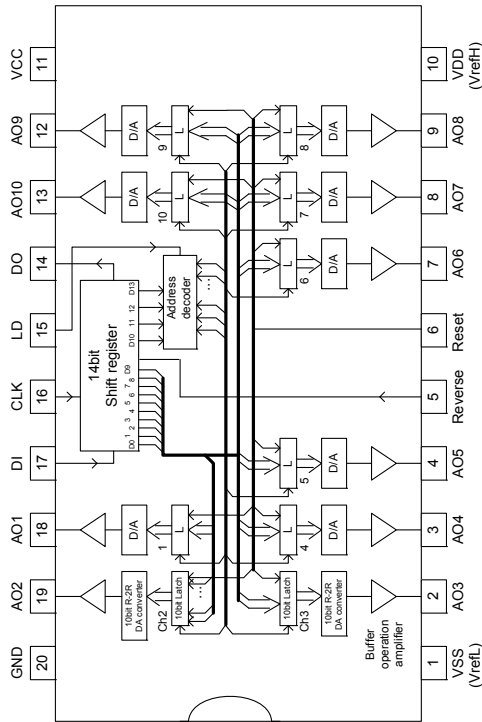


Therefore, it is better to control LD port of each LSI separately, if extra CPU ports are available.

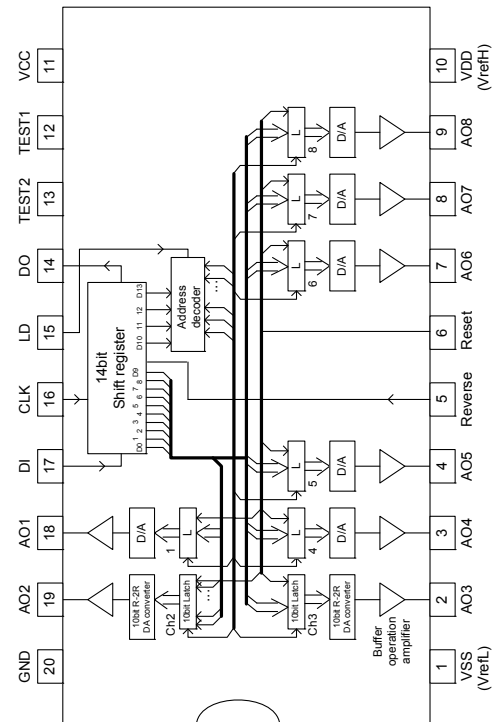
In this case, more ports to control LD signals are needed, but a consideration described above doesn't have to be done.



BU2505FV



BU2506FV



● Terminal Descriptions

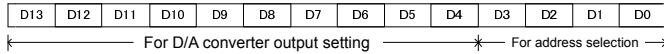
No.	Terminal Name	Analog / Digital	I/O	Description	Equivalent Circuit
1	VSS	Analog	-	DA converter lower standard voltage (VrefL) input terminal	6
2	AO3	Analog	O	10bit D/A output(CH3)	4
3	AO4	Analog	O	10bit D/A output(CH4)	4
4	AO5	Analog	O	10bit D/A output(CH5)	4
5	Reverse	Digital	I	The reverse LSB and MSB of data designation 10bit in 14bit.	2
6	Reset	Digital	I	All ch analog output L fixed	2
7	AO6	Analog	O	10bit D/A output(CH6)	4
8	AO7	Analog	O	10bit D/A output(CH7)	4
9	AO8	Analog	O	10bit D/A output(CH8)	4
10	VDD	Analog	-	DA converter upper standard voltage (VrefH) input terminal	5
11	VCC	-	-	Power source terminal	-
12	AO9(TEST1)	Analog	O	10bit D/A output(CH9) (BU2506FV : test terminal)	4
13	AO10(TEST2)	Analog	O	10bit D/A output(CH10) (BU2506FV : test terminal)	4
14	DO	Digital	O	This outputs bit data of LSB of 14bit shift register.	3
15	LD	Digital	I	LD terminal. When High level is input, the value of 14bit shift register is loaded to decoder and D/A output register.	1
16	CLK	Digital	I	Shift clock input terminal. At rise of shift clock, the signal from DI terminal is input to 14bit shift register.	1
17	DI	Digital	I	Serial data input terminal. Serial data whose data length is 14bit (address 4bit + data 10bit) is input.	1
18	AO1	Analog	O	10bit D/A output(CH1)	4
19	AO2	Analog	O	10bit D/A output(CH2)	4
20	GND	-	-	GND terminal	-

*In the case of BU2506FV, be sure to leave the TEST1 and TEST2 terminals open

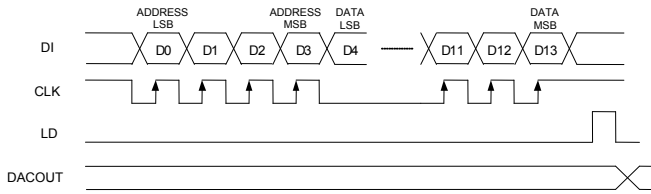
● Command Transmission

1) Reverse = open (or VCC short-circuit) setting

(1) Data format



(2) Data timing diagram

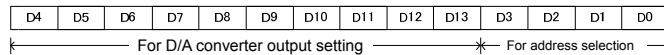


D3	D2	D1	D0	Address Selection
0	0	0	0	Inconsequential
0	0	0	1	AO1 selection
0	0	1	0	AO2 selection
0	0	1	1	AO3 selection
0	1	0	0	AO4 selection
0	1	0	1	AO5 selection
0	1	1	0	AO6 selection
0	1	1	1	AO7 selection
1	0	0	0	AO8 selection
1	0	0	1	AO9 selection ^{*1}
1	0	1	0	AO10 selection ^{*1}
1	0	1	1	Inconsequential
1	1	0	0	Inconsequential
1	1	0	1	Inconsequential
1	1	1	0	Inconsequential
1	1	1	1	Inconsequential

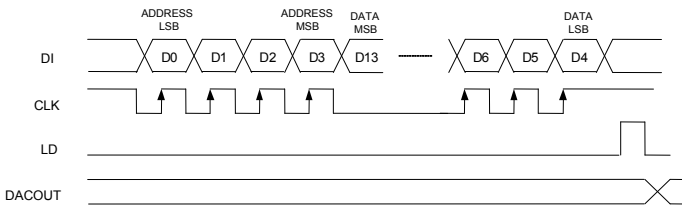
D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D/A output (VrefH=VDD, VrefL=VSS)
0	0	0	0	0	0	0	0	0	0	VrefL
0	0	0	0	0	0	0	0	0	1	$(VrefH-VrefL)/1024 \times 1 + VrefL$
0	0	0	0	0	0	0	0	1	0	$(VrefH-VrefL)/1024 \times 2 + VrefL$
0	0	0	0	0	0	0	0	1	1	$(VrefH-VrefL)/1024 \times 3 + VrefL$
:	:	:	:	:	:	:	:	:	:	:
1	1	1	1	1	1	1	1	1	0	$(VrefH-VrefL)/1024 \times 1022 + VrefL$
1	1	1	1	1	1	1	1	1	1	$(VrefH-VrefL)/1024 \times 1023 + VrefL$

2) Reverse = L setting

(1) Data format



(2) Data timing diagram



D3	D2	D1	D0	Address selection
0	0	0	0	Inconsequential
0	0	0	1	AO1 selection
0	0	1	0	AO2 selection
0	0	1	1	AO3 selection
0	1	0	0	AO4 selection
0	1	0	1	AO5 selection
0	1	1	0	AO6 selection
0	1	1	1	AO7 selection
1	0	0	0	AO8 selection
1	0	0	1	AO9 selection ^{*1}
1	0	1	0	AO10 selection ^{*1}
1	0	1	1	Inconsequential
1	1	0	0	Inconsequential
1	1	0	1	Inconsequential
1	1	1	0	Inconsequential
1	1	1	1	Inconsequential

D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D/A output (VrefH=VDD, VrefL=VSS)
0	0	0	0	0	0	0	0	0	0	VrefL
1	0	0	0	0	0	0	0	0	0	$(VrefH-VrefL)/1024 \times 1 + VrefL$
0	1	0	0	0	0	0	0	0	0	$(VrefH-VrefL)/1024 \times 2 + VrefL$
1	1	0	0	0	0	0	0	0	0	$(VrefH-VrefL)/1024 \times 3 + VrefL$
:	:	:	:	:	:	:	:	:	:	:
0	1	1	1	1	1	1	1	1	1	$(VrefH-VrefL)/1024 \times 1022 + VrefL$
1	1	1	1	1	1	1	1	1	1	$(VrefH-VrefL)/1024 \times 1023 + VrefL$

*1 In the BU2506FV, this channel is for testing, therefore, do not designate.

●Electrical Characteristics Curves

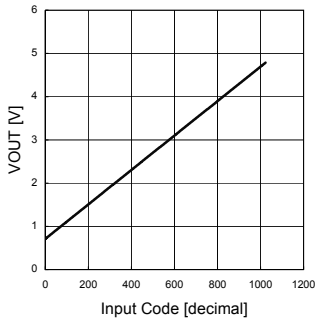


Fig.1 Output voltage linearity (-30°C)

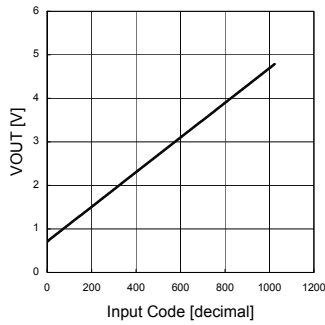


Fig.2 Output voltage linearity (25°C)

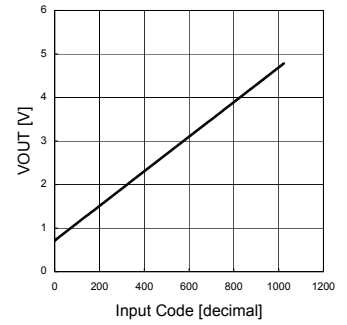


Fig.3 Output voltage linearity (85°C)

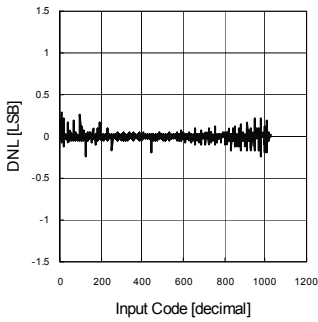


Fig.4 Differential linearity error (-30°C)

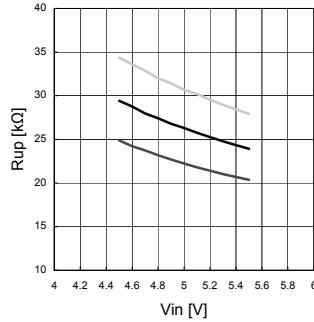


Fig.5 Differential linearity error (25°C)

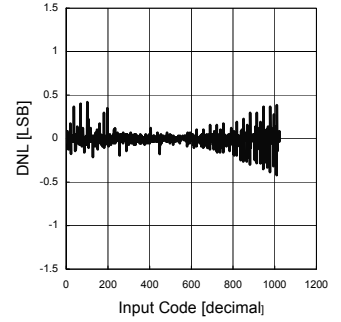


Fig.6 Differential linearity error (85°C)

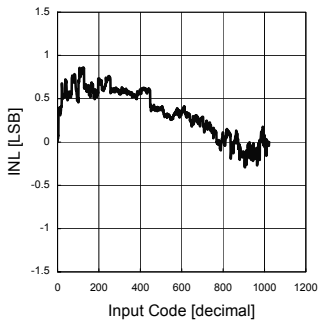


Fig.7 Integral linearity error (-30°C)

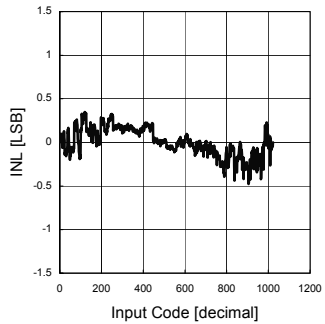


Fig.8 Integral linearity error (25°C)

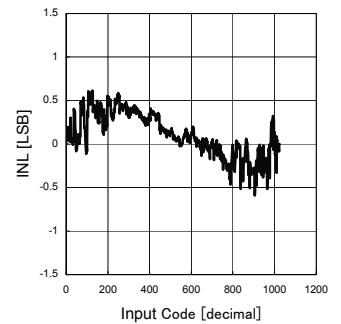


Fig.9 Integral linearity error (85°C)

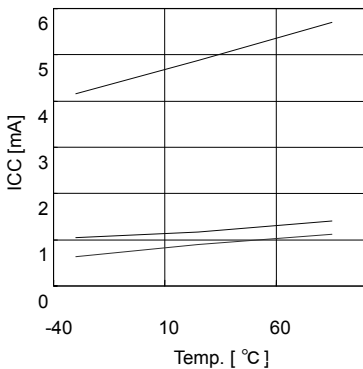


Fig.10 Circuit current temperature characteristic

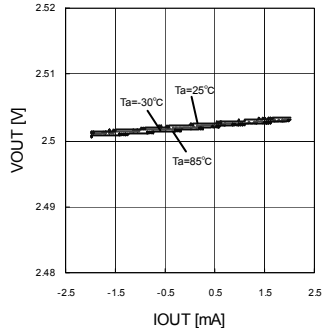


Fig.11 Output load fluctuation characteristic (input code: 1FFh)

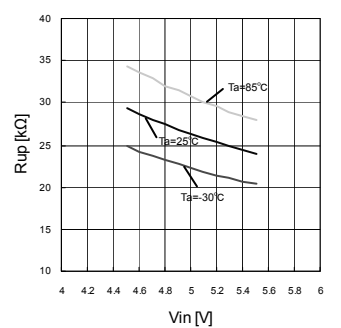
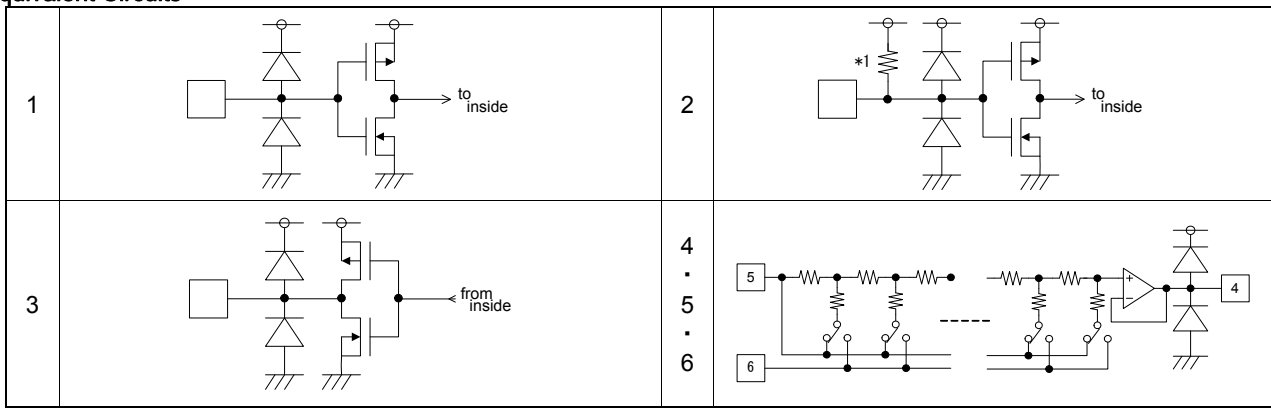


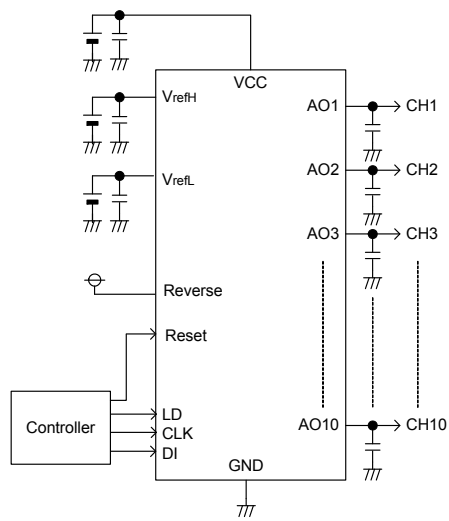
Fig.12 Pull-up built in resistance characteristic

●Equivalent Circuits



*1 25kΩ at Vcc = 5.0V (changes according to voltage supplied)

●Standard Example Application Circuit



●Operation Notes

- (1) The electrical characteristic and data on graphs for this datasheet, are typically evaluated value, and not guaranteed.
- (2) We suppose that application circuits are recommendable, but please make sufficient check for characteristics with the actual application. In case that value of external component for this LSI is changed, please check characteristic, not only static but also transient.
- (3) About absolute maximum ratings
If operation condition is over the absolute maximum ratings, supply voltage or other operation range, LSI will be broken. Please don't apply any voltage or temperature over the absolute maximum ratings. If application have possibilities of become over the absolute maximum ratings, please take safety measures by using fuse and so on. Not to over absolute maximum ratings of LSI.
- (4) GND voltage
Please keep GND voltage lowest of any other terminal of this LSI. Please confirm that other terminal voltages are not lower than GND.
- (5) Thermal design
Please making a thermal design that allows for a sufficient margin in light of the power dissipation in actual operating condition.
- (6) About terminals short and wrong mounting
Please pay full attention to the LSI direction and displacement when mounting LSI on PCB. If you assemble them by mistake and electrify it, LSI might be destroyed. And it is happen to short among LSI terminals or terminals and power supply, by foreign substance.
- (7) About operation in strong electromagnetic field
If you use it in strong electromagnetic field, please evaluate fully as there is a possibility of malfunction.
- (8) Place a bypass capacitor as close as possible between each power supply terminal and ground in order to prevent deterioration of the D/A conversion accuracy due to ripple and noise signals from power supply or GND.
- (9) A capacitor should be placed between the analog output and ground in order to eliminate noise.
A capacitance up to 100pF is recommended (including the capacitance of the wire).
- (10) This IC is selectable to decode the 10bit DI data pattern using either LSB first or MSB first, depending on the conditions of the REVERSE terminal. Therefore the reverse terminal should be open or VDD voltage (LSB first) or GND voltage (MSB first)

● Ordering part number

B	U
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Part No.

2	5	0	6
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Part No.
2506
2505

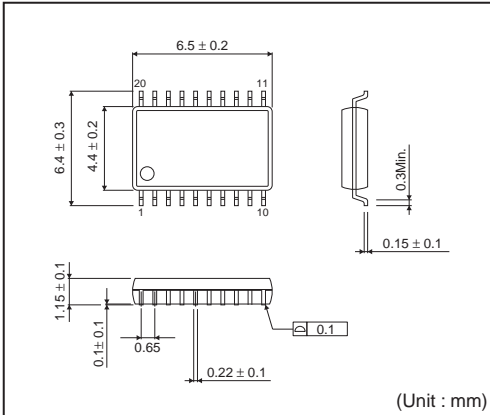
F	V
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Package
FV: SSOP-B20

E	2
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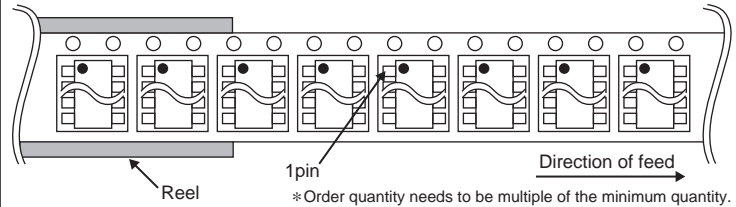
Packaging and forming specification
E2: Embossed tape and reel

SSOP-B20



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1 pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)



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